

Datasheet revision 1.3 www.chipquik.com

Solder Wire Sn60/Pb40 No-Clean with 2.2% Flux Core 1oz Spool

Product Highlights

No-Clean Synthetic Flux Core

The clear, non-corrosive, non-conductive residue is meant to be left on the board. 2.2% flux core

Halogen content: None

Specifications

Sn60/Pb40 Alloy: Wire Diameter: 0.015" (0.38mm) Flux Type: No-Clean Synthetic

Flux Classification: ROL0

Melting Point: 183-188°C (361-370°F)

Packaging: 1 oz spool Shelf Life: >60 months



Test Results

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Test J-STD-004 or other requirements as stated	Test Requirement	Result
•	IDO TM 050, 0 0 00	I. No bus alethus cub
Copper Mirror	IPC-TM-650: 2.3.32	L: No breakthrough
Corrosion	IPC-TM-650: 2.6.15	L: No corrosion
Quantitative Halides	IPC-TM-650: 2.3.28.1	L: <0.05%
Electrochemical Migration	IPC-TM-650: 2.6.14.1	L: <1 decade drop (No-clean)
Surface Insulation Resistance 85°C,	IPC-TM-650: 2.6.3.7	L: ≥100MΩ (No-clean)
85% RH @ 168 Hours		,
Visual	IPC-TM-650: 3.4.2.5	Clear and free from precipitation
Conflict Minerals Compliance	Electronic Industry Citizenship Coalition (EICC)	Compliant
REACH Compliance	Articles 33 and 67 of Regulation (EC) No 1907/2006	Contains Lead (Pb) CAS# 7439-92-1 No other SVHC present

Conforms to the following Industry Standards:

J-STD-004B, Amendment 1 (Solder Fluxes):

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders): No

RoHS 3 Directive (EU) 2015/863:

Yes

Yes

Mouser Electronics

Authorized Distributor

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Chip Quik:

NC2SW.015 1OZ